NGP8203N

Ignition IGBT

20 A, 400 V, N−Channel TO−220

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Overvoltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

Features

- Ideal for Coil−on−Plug and Driver−on−Coil Applications
- Gate−Emitter ESD Protection
- Temperature Compensated Gate−Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage for Interfacing Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- Optional Gate Resistor (R_G) and Gate−Emitter Resistor (R_{GE})

Applications

- Ignition Systems

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector−Emitter Voltage	V_{CES}	440	V
Collector−Gate Voltage	V_{CER}	440	V
Gate−Emitter Voltage	V_{GE}	±15	V
Collector Current−Continuous @ T_C = 25°C − Pulsed	I_C	20 50	A_{DC} A_{AC}
Continuous Gate Current	I_G	1.0	mA
Transient Gate Current (t≤2 ms, f≤100 Hz)	I_G	20	mA
ESD (Charged−Device Model)	ESD	2.0	kV
ESD (Human Body Model) R = 1500 Ω, C = 100 pF	ESD	8.0	kV
ESD (Machine Model) R = 0 Ω, C = 200 pF	ESD	500	V
Total Power Dissipation @ T_C = 25°C Derate above 25°C	P_D	150 1.0	Watts W/°C
Operating & Storage Temperature Range	T_J, T_{stg}	−55 to +175	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

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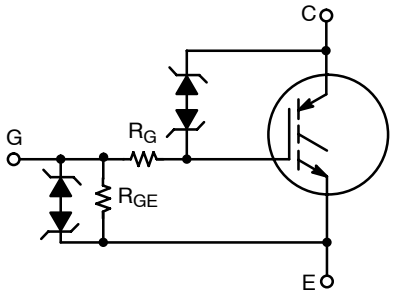
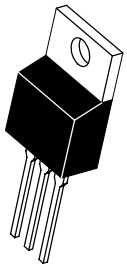
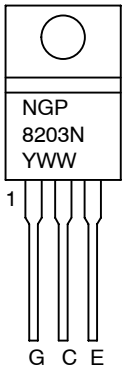
20 AMPS
400 VOLTS
$V_{CE(on)}$ = 1.3 V @
I_C = 10 A, V_{GE} ≥ 4.5 V





TO−220
CASE 221A
STYLE 9

MARKING DIAGRAM



NGP8203N = Device Code
Y = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
NGP8203N	TO−220	50 Units / Rail

UNCLAMPED COLLECTOR−TO−EMITTER AVALANCHE CHARACTERISTICS (−55° ≤ T_J ≤ 175°C)

Characteristic	Symbol	Value	Unit
Single Pulse Collector−to−Emitter Avalanche Energy V_{CC} = 50 V, V_{GE} = 5.0 V, Pk I_L = 16.7 A, R_G = 1000 Ω, L = 1.8 mH, Starting T_J = 25°C V_{CC} = 50 V, V_{GE} = 5.0 V, Pk I_L = 14.9 A, R_G = 1000 Ω, L = 1.8 mH, Starting T_J = 150°C V_{CC} = 50 V, V_{GE} = 5.0 V, Pk I_L = 14.1 A, R_G = 1000 Ω, L = 1.8 mH, Starting T_J = 175°C	E_{AS}	 250 200 180	mJ
Reverse Avalanche Energy V_{CC} = 100 V, V_{GE} = 20 V, Pk I_L = 25.8 A, L = 6.0 mH, Starting T_J = 25°C	$E_{AS(R)}$	2000	mJ

THERMAL CHARACTERISTICS

Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	1.0	°C/W
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$	62.5	°C/W
Maximum Temperature for Soldering Purposes, 1/8″ from case for 5 seconds (Note 1)	T_L	275	°C

1. For further details, see Soldering and Mounting Techniques Reference Manual: SOLDERRM/D.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
OFF CHARACTERISTICS							
Collector−Emitter Clamp Voltage	BV_{CES}	I_C = 2.0 mA	T_J = −40°C to 175°C	370	395	420	V
		I_C = 10 mA	T_J = −40°C to 175°C	390	415	440	
Zero Gate Voltage Collector Current	I_{CES}	V_{GE} = 0 V, V_{CE} = 15 V	T_J = 25°C		0.1	1.0	μA
		V_{CE} = 200 V, V_{GE} = 0 V	T_J = 25°C	0.5	1.5	10	μA
			T_J = 175°C	1.0	25	100*	
			T_J = −40°C	0.4	0.8	5.0	
Reverse Collector−Emitter Clamp Voltage	$B_{VCES(R)}$	I_C = −75 mA	T_J = 25°C	30	35	39	V
			T_J = 175°C	35	39	45*	
			T_J = −40°C	30	33	37	
Reverse Collector−Emitter Leakage Current	$I_{CES(R)}$	V_{CE} = −24 V	T_J = 25°C	0.05	0.1	0.5	mA
			T_J = 175°C	1.0	5.0	10*	
			T_J = −40°C	0.005	0.01	0.1	
Gate−Emitter Clamp Voltage	BV_{GES}	I_G = ±5.0 mA	T_J = −40°C to 175°C	12	12.5	14	V
Gate−Emitter Leakage Current	I_{GES}	V_{GE} = ±5.0 V	T_J = −40°C to 175°C	200	300	350*	μA
Gate Resistor (Optional)	R_G		T_J = −40°C to 175°C		70		Ω
Gate−Emitter Resistor	R_{GE}		T_J = −40°C to 175°C	14.25	16	25	kΩ
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	$V_{GE(th)}$	I_C = 1.0 mA, V_{GE} = V_{CE}	T_J = 25°C	1.5	1.8	2.1	V
			T_J = 175°C	0.7	1.0	1.3	
			T_J = −40°C	1.7	2.0	2.3*	
Threshold Temperature Coefficient (Negative)				4.0	4.6	5.2	mV/°C

*Maximum Value of Characteristic across Temperature Range.

2. Pulse Test: Pulse Width ≤ 300 μS, Duty Cycle ≤ 2%.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Test Conditions	Temperature	Min	Typ	Max	Unit
ON CHARACTERISTICS (Note 3)							
Collector−to−Emitter On−Voltage	$V_{CE(on)}$	I_C = 6.5 A, V_{GE} = 3.7 V	T_J = 25°C	0.95	1.15	1.35	V
			T_J = 175°C	0.7	0.95	1.15	
			T_J = −40°C	1.0	1.3	1.40	
		I_C = 9.0 A, V_{GE} = 3.9 V	T_J = 25°C	0.95	1.25	1.45	
			T_J = 175°C	0.8	1.05	1.25	
			T_J = −40°C	1.1	1.4	1.5	
		I_C = 7.5 A, V_{GE} = 4.5 V	T_J = 25°C	0.85	1.15	1.4	
			T_J = 175°C	0.7	0.95	1.2	
			T_J = −40°C	1.0	1.3	1.6*	
		I_C = 10 A, V_{GE} = 4.5 V	T_J = 25°C	1.0	1.3	1.6	
			T_J = 175°C	0.8	1.05	1.4	
			T_J = −40°C	1.1	1.4	1.7*	
		I_C = 15 A, V_{GE} = 4.5 V	T_J = 25°C	1.15	1.45	1.7	
			T_J = 175°C	1.0	1.3	1.55	
			T_J = −40°C	1.25	1.55	1.8*	
		I_C = 20 A, V_{GE} = 4.5 V	T_J = 25°C	1.3	1.6	1.9	
			T_J = 175°C	1.2	1.5	1.8	
			T_J = −40°C	1.4	1.75	2.0*	
Forward Transconductance	gfs	I_C = 6.0 A, V_{CE} = 5.0 V	T_J = 25°C	10	18	25	Mhos
DYNAMIC CHARACTERISTICS							
Input Capacitance	C_{ISS}	f = 10 kHz, V_{CE} = 25 V	T_J = 25°C	1100	1300	1500	pF
Output Capacitance	C_{OSS}			70	80	90	
Transfer Capacitance	C_{RSS}			18	20	22	
SWITCHING CHARACTERISTICS							
Turn−Off Delay Time (Resistive)	$t_{d(off)}$	V_{CC} = 300 V, I_C = 9.0 A, R_G = 1.0 kΩ, R_L = 33 Ω, V_{GE} = 5.0 V	T_J = 25°C	6.0	8.0	10	μSec
			T_J = 175°C	6.0	8.0	10	
Fall Time (Resistive)	t_f		T_J = 25°C	4.0	6.0	8.0	
			T_J = 175°C	8.0	10.5	14	
Turn−Off Delay Time (Inductive)	$t_{d(off)}$	V_{CC} = 300 V, I_C = 9.0 A, R_G = 1.0 kΩ, L = 300 μH, V_{GE} = 5.0 V	T_J = 25°C	3.0	5.0	7.0	
			T_J = 175°C	5.0	7.0	9.0	
Fall Time (Inductive)	t_f		T_J = 25°C	1.5	3.0	4.5	
			T_J = 175°C	5.0	7.0	10	
Turn−On Delay Time	$t_{d(on)}$	V_{CC} = 14 V, I_C = 9.0 A, R_G = 1.0 kΩ, R_L = 1.5 Ω, V_{GE} = 5.0 V	T_J = 25°C	1.0	1.5	2.0	
			T_J = 175°C	1.0	1.5	2.0	
Rise Time	t_r		T_J = 25°C	4.0	6.0	8.0	
			T_J = 175°C	3.0	5.0	7.0	

*Maximum Value of Characteristic across Temperature Range.

3. Pulse Test: Pulse Width ≤ 300 μS, Duty Cycle ≤ 2%.

TYPICAL ELECTRICAL CHARACTERISTICS

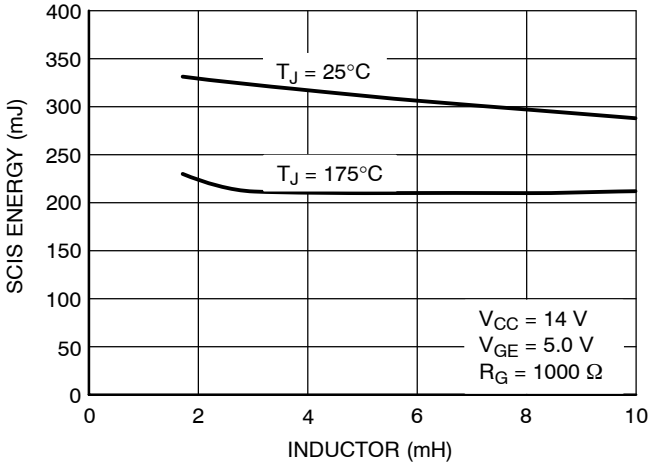


Figure 1. Self Clamped Inductive Switching

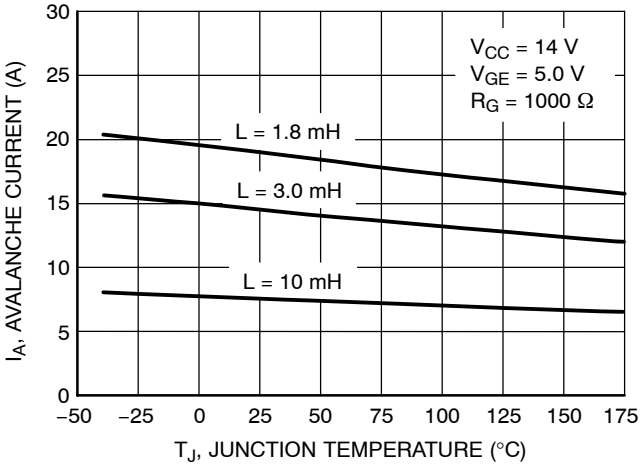


Figure 2. Open Secondary Avalanche Current vs. Temperature

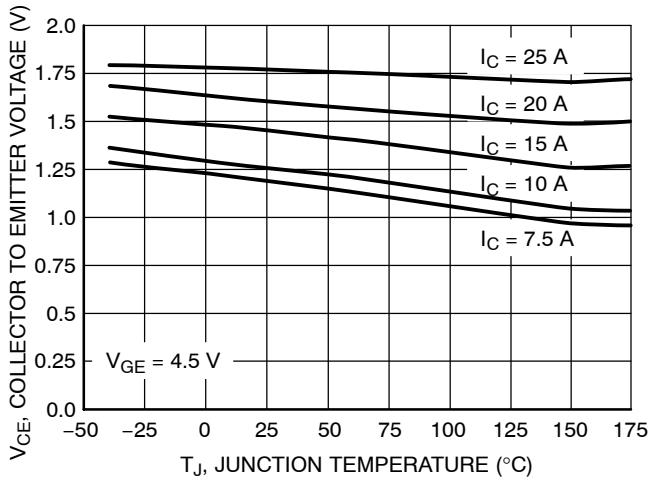


Figure 3. Collector−to−Emitter Voltage vs. Junction Temperature

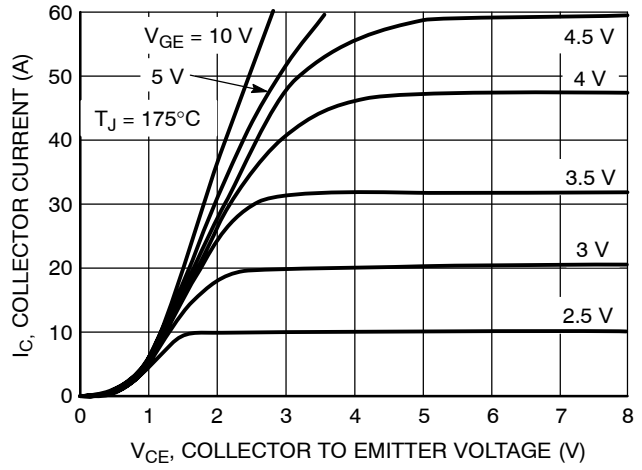


Figure 4. Collector Current vs. Collector−to−Emitter Voltage

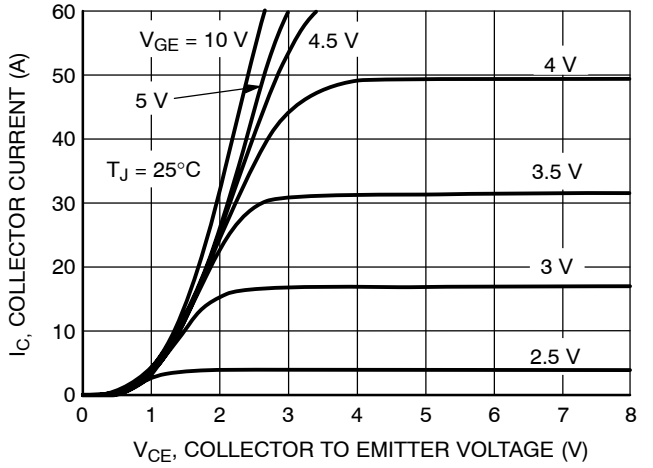


Figure 5. Collector Current vs. Collector−to−Emitter Voltage

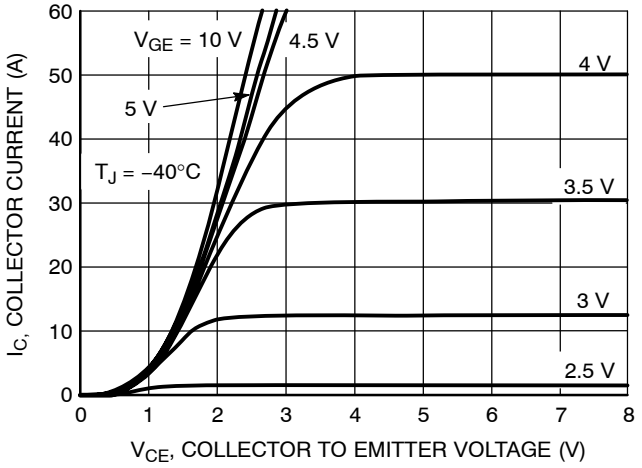


Figure 6. Collector Current vs. Collector−to−Emitter Voltage

TYPICAL ELECTRICAL CHARACTERISTICS

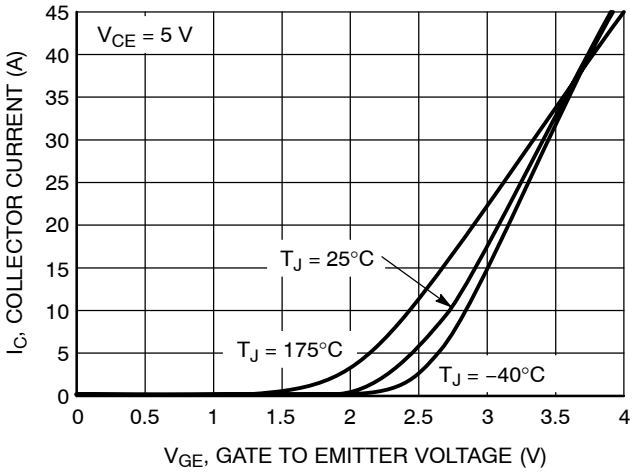


Figure 7. Transfer Characteristics

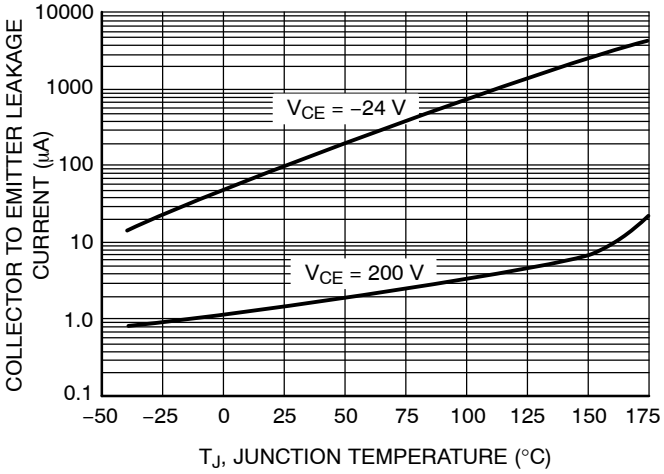


Figure 8. Collector−to−Emitter Leakage Current vs. Temperature

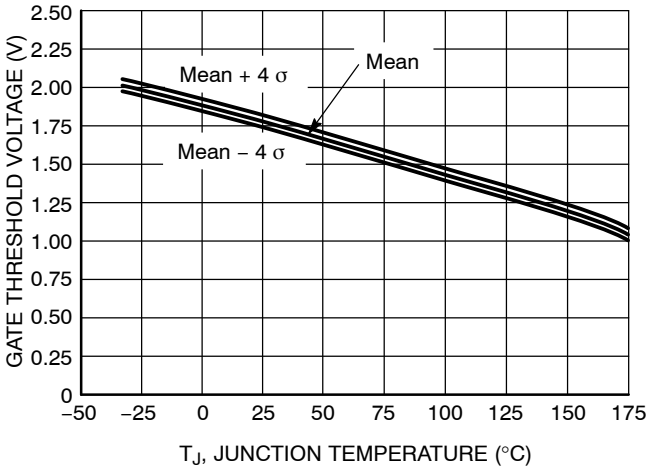


Figure 9. Gate Threshold Voltage vs. Temperature

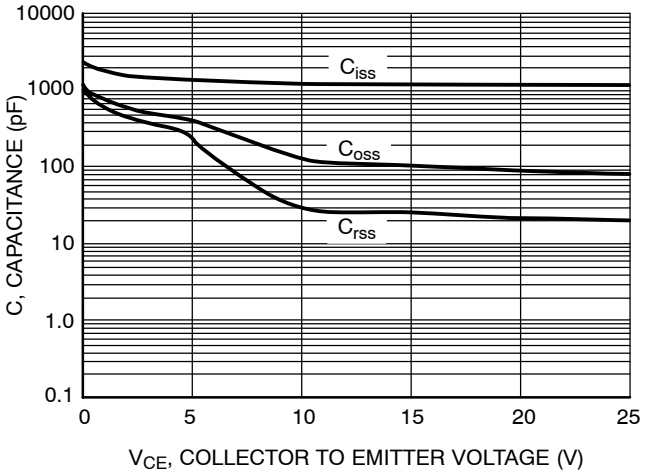


Figure 10. Capacitance vs. Collector−to−Emitter Voltage

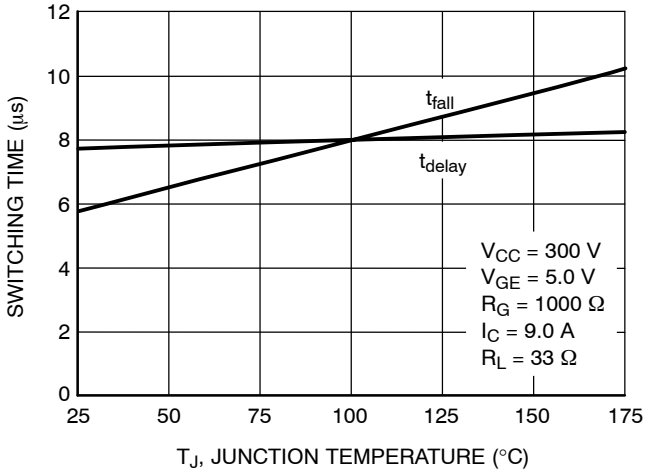


Figure 11. Resistive Switching Fall Time vs. Temperature

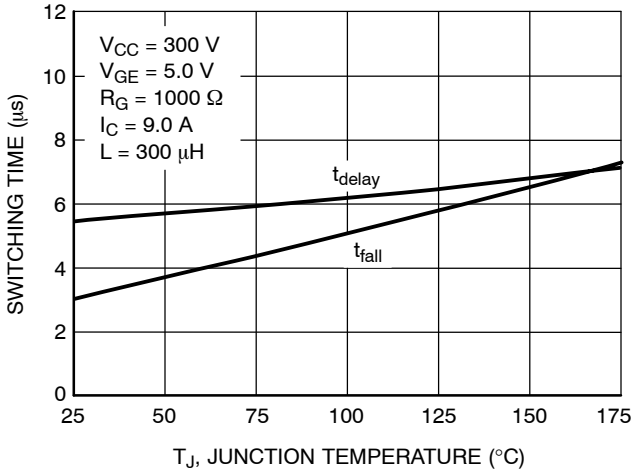


Figure 12. Inductive Switching Fall Time vs. Temperature

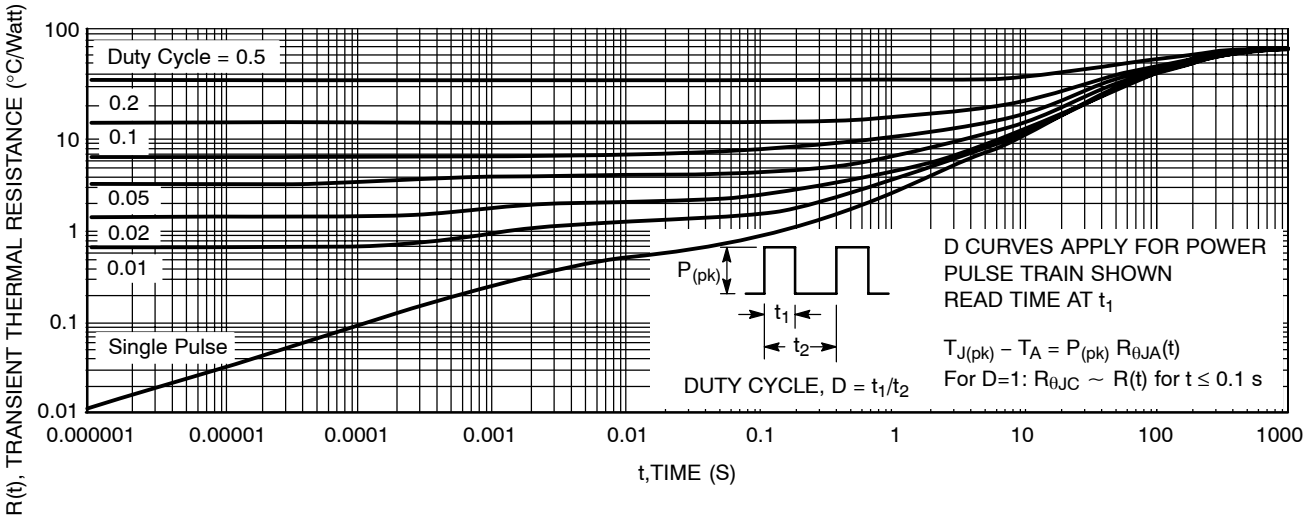


Figure 13. Transient Thermal Resistance (Non−normalized Junction−to−Ambient)

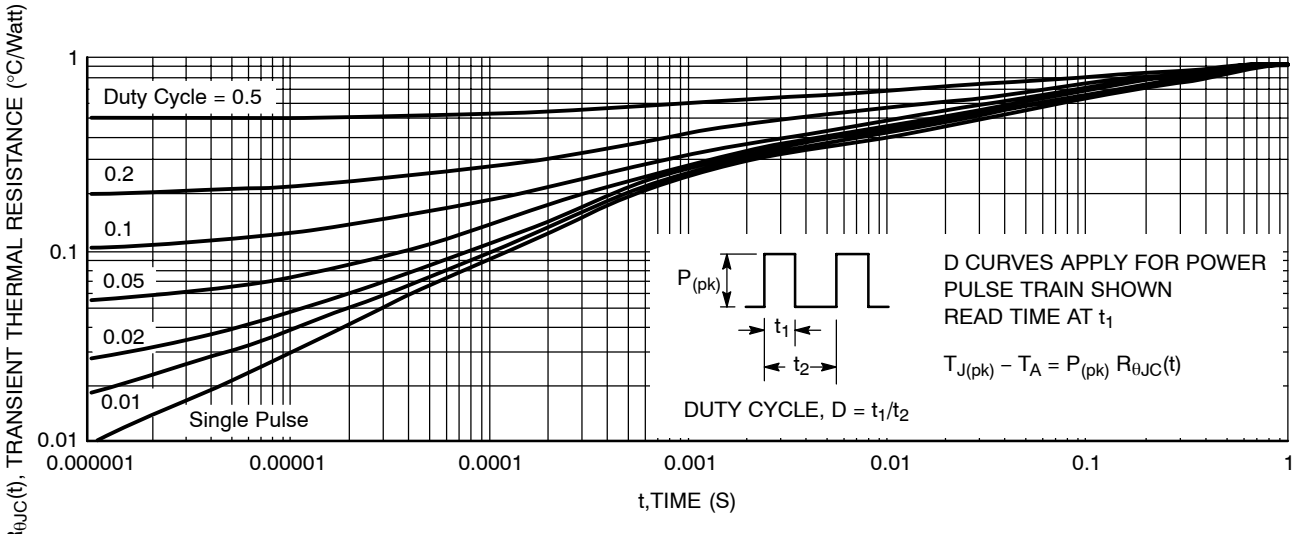
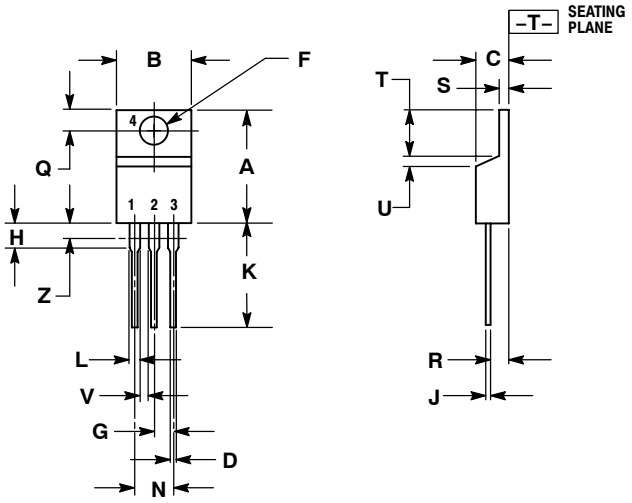


Figure 14. Best Case Transient Thermal Resistance (Non−normalized Junction−to−Case Mounted on Cold Plate)

PACKAGE DIMENSIONS

TO−220
CASE 221A−09
ISSUE AD



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 9:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

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